DMT150XGHLNT0-1A PRODUCT SPECIFICATION

Version 1.4 Nov 17, 2022





Customer's Approval			
<u>Signature</u>	<u>Date</u>		

Prepared by *Victoria Ho*Approved by *Evan Huang*

Revision History

VERSION	DATE	DESCRIPTION	AUTHOR			
1.0	Sep 03, 2021	Revised Storage temperature	Chi Huang			
		Page.25 Added packaging method				
		Add conductive foam to FOG's PCB"				
		p.11 Update 3.2.2 Backlight				
1.1	Nov 09, 2021	P.12 Update 3.3 Interface Pin Assignment	Chi Huang			
		P.25 Update 6. Quality Assurance Specification				
		P.31~32 Update 7. 7. Reliability Specification				
		p.5 Added Side screw torque and material type of metal				
		p.6~7 updated the drawing				
4.2	D 00 2024	p.11 Added note3	Chi Uluana			
1.2	Dec 08, 2021	p.12 Added plating of connector contact in note1	Chi Huang			
		p.15 updated the table of data signal				
1.3	Nov 11, 2022	p.26 modify the definition of 2 adjacent bright dots	Victoria Ho			
1.4	Nov 17, 2022	Modify dot==>sub pixel	Victoria Ho			

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General Description

1.1Introduction

This is a 15.0" size colour active matrix TFT LCD module that uses amorphous silicon TFT as a switching device. The display is normally black mode and featuring high contrast and excellent colour saturation. The resolution of the TFT-LCD is 1024 x 768 and can display up to 16.7M/262K colours. The display module supports LVDS interface.

1.2 Main Features

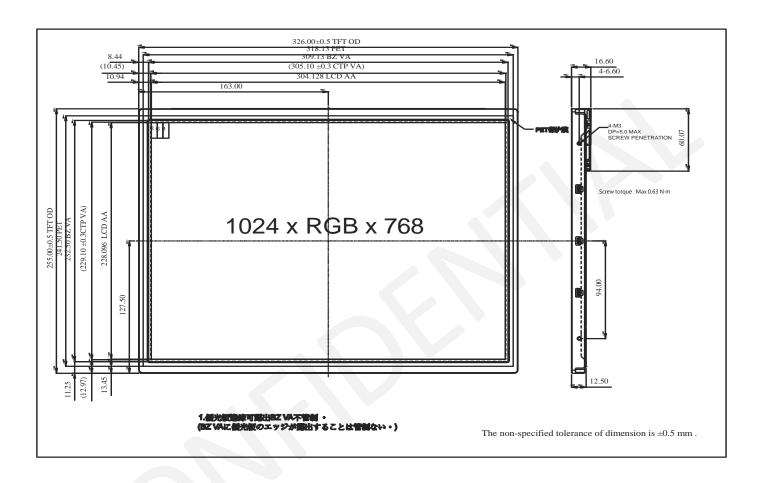
Item	Contents			
Display Type	TFT LCD			
Screen Size	15.0" Diagonal			
Display Format	1024 x RGB x 768 Pixels			
No. of Colour	16.7M/262K			
Overall Dimensions	326.0(W) x 255.0 (H) x 16.6 (D) mm			
Active Area	304.128 (W) x 228.096(H) mm			
Mode	Normally Black / VA			
Surface Treatment	Hard Coating (3H), Anti-Glare			
Viewing Direction	All round			
Interface	6/8-bit LVDS			
Backlight Type	LED			
Operating Temperature	-20°C ~ +70°C			
Storage Temperature	-20°C ~ +80°C			
ROHS	Compliant to RoHS 2.0			

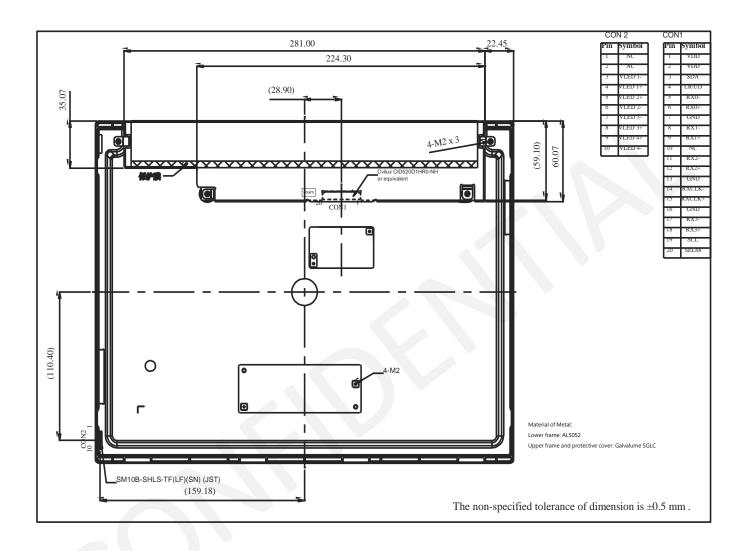
2. Mechanical Specification

2.1 Mechanical Characteristics

Item	Characteristic	Unit
Display Format	1024 x RGB x 768	Pixels
Overall Dimensions	326.0(W) x 255.0 (H) x 16.6 (D)	mm
Active Area	304.128 (W) x 228.096(H)	mm
Pixel Pitch	0.297 (W) x 0.297 (H)	mm
Weight	970	g
Side screw torque	Max 0.63 N • m (This is a reference value, does not provide screws.)	
Material of Lower frame	AL5052	
Material of Upper frame	Galvalume SGLC	
Material of protective cover	Galvalume SGLC	

2.2 Mechanical Drawing





3. Electrical Specification

3.1 Absolute Maximum Ratings

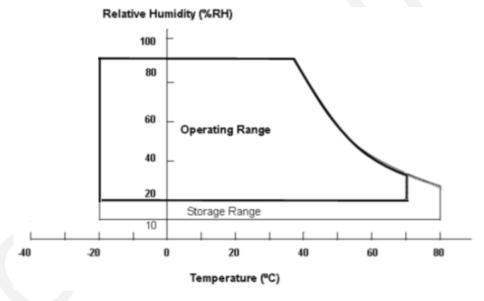
Absolute Ratings of Environment 3.1.1

Item	Symbol	Min	Max	Unit	Note
Operating Ambient Temperature	Тор	-20	+70	°C	1, 2, 3
Storage Temperature	Тѕт	-20	+80	°C	1, 2, 3

Note 1: Temperature define as the ambient temperature. Temperature and relative humidity range is shown in the figure below.

Note 2: 90 %RH Max. (Ta < 40° C).

Note 3: Wet-bulb temperature should be 39° C Max.



Storage Conditions 3.1.2

High temperature or humidity may reduce the performance of panel. Please store LCD panel within the specified storage conditions.

Storage Condition: With packing. Storage temperature range: 25±5 °C.

Storage humidity range: 50±10%RH.

Shelf life: 30days

3.1.3 Electrical Absolute Ratings

3.1.2.1 TFT LCD Module

Item	Symbol	Min	Max	Unit	Note
Power Supply Voltage	VCC	-0.3	4	V	1
Logic Input Voltage	VI	-0.3	VCC+0.3	V	

Note 1: Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

3.1.2.2 Backlight Unit

Item	Symbol	Min	Max	Unit	Note
Backlight (LED) Current	IF	0	180	mA	1, 2, 3

Note 1: Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note 2: Specified values are for lamp (Refer to 6.1 for further information).

Note 3: 1 LED String



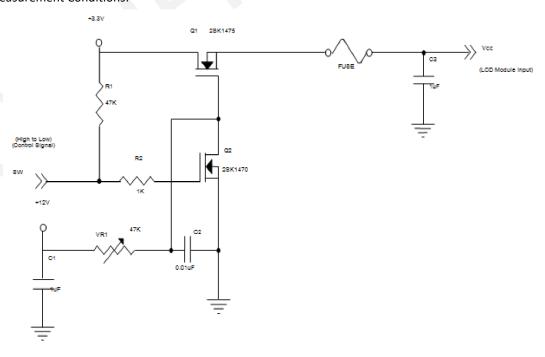
3.2 Electrical Characteristics

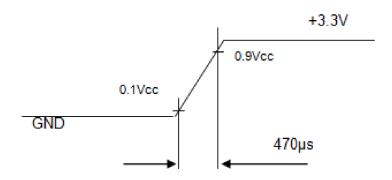
3.2.1 TFT LCD Module

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note	
Power Supply Vo	ltage	Vcc	-	3.0	3.3	3.6	V	-
Ripple Voltag	e	V _{RP}	-		-	100	mVP-p	-
Rush Curren	Rush Current		-	-	-	2.0	А	2
Daniel Community	White	lcc		-	455	545	mA	3a
Power Supply Current	Black		-	-	350	420	mA	3b
LVDS Differential Inpu	ıt Voltage	Vid	-	200	-	600	mV	-
LVDS Common Input	Voltage	Vic	-	1.0	1.2	1.4	V	-
Differential Input	"H" Level	V _{IH}	-	-	-	100	mV	-
Voltage for LVDS Receiver Threshold "L" Level		VIL	-	-100	_	-	mV	-
Terminating Res	istor	RT	-	-	100	-	Ohm	-

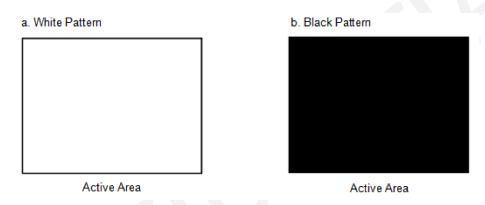
Note 1: The assembly should be always operated within above ranges.

Note 2: Measurement Conditions:



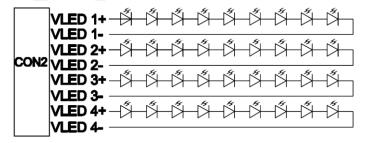


Note 3: The specified power supply is under the conditions at VDD=3.3V, Ta=25 \pm 2 $^{\circ}$ C, DC Current and fv = 60Hz, whereas a power dissipation check pattern below is displayed.



3.2.2 Backlight

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
LED Voltage	VF	IF=110mA,Ta=25℃	-	(27)	32.4	V	1
LED Current	IF	Ta=25℃	-	4*110	120	mA	-
LED Life Time	LT	IF=110mA,Ta=25℃	80,000	100,000	-	h	1



Note 1. The single LED lamp case. Brightness to be decreased to 50% of the initial value

3.3 Interface Pin Assignment

3.3.1 TFT LCD Module (CN1)

No.	Symbol	I/O	Function	Polarity	Note
1	VCC	Р	Power Supply: +3.3V (typical)	-	-
2	VCC	Р	Power Supply: +3.3V (typical)	-	-
3	NC	-	No Connection (Reserve for inner test)	-	4
			Reverse Scan Control		
4	LR/UD	I	H or NC = Normal Mode.	-	3
			L = Horizontal / Vertical Reverse Scan.		
5	RXO-	I	LVDS Differential Data Input	Negative	-
6	RXO+	I	LVDS Differential Data Input	Positive	-
7	GND	Р	Ground	-	-
8	RX1-	I	LVDS Differential Data Input	Negative	-
9	RX1+	I	LVDS Differential Data Input	Positive	-
10	NC	-	No Connection (Reserve for inner test)	-	4
11	RX2-	I	LVDS Differential Data Input	Negative	-
12	RX2+	I	LVDS Differential Data Input	Positive	-
13	GND	Р	Ground	-	-
14	RXCLK-	I	LVDS Differential Data Input	Negative	-
15	RXCLK+	I	LVDS Differential Data Input	Positive	-
16	GND	Р	Ground	-	-
17	RX3-		LVDS Differential Data Input	Negative	-
18	RX3+	1	LVDS Differential Data Input	Positive	-
19	NC	-	No Connection (Reserve for inner test)	-	4
			LVDS 6/8 bit select function control,		
20	SEL68	1	High=6bit Input Mode	-	3
			Low or NC=8bit Input Mode		

- Note 1. Connector Part No.: Cvilux CID520D1HR0-NH (Matte Tin Plated) or equivalent.
- Note 2. User's connector Part No.: Hirose DF14-20S-1.25C or equivalent.
- Note 3. "Low" stands for 0V. "High" stands for 3.3V. "NC" stands for "No Connection".
- Note 4. Pin3, Pin10, Pin19 input signals should be set to no connection or ground, this module would operate normally.
- Note 5. Pin3, Pin19 are I2C bus. Flicker can adjust by using the software of Auto-Vcom,

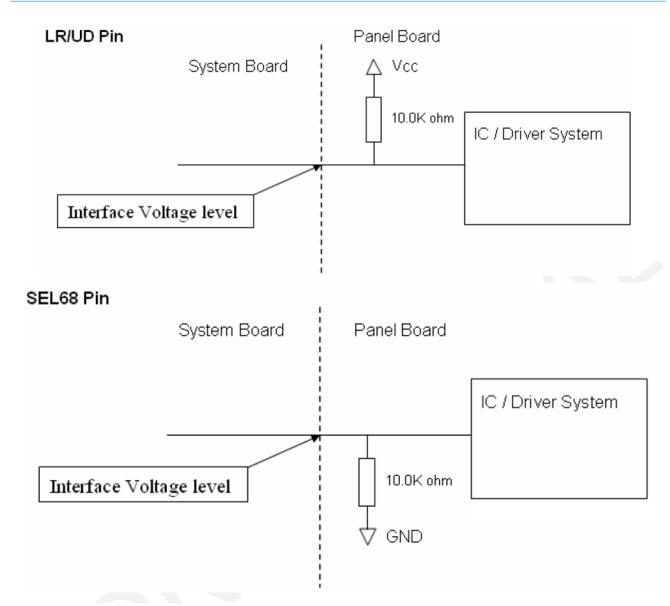


Fig.1 Normal Scan



Fig. 1 Normal scan (Pin 4, LR/UD = High or NC)

Fig.2 Reverse Scan



Fig. 2 Reverse scan (Pin 4, LR/UD = Low)

BACKLIGHT UNIT (CN2) 3.3.2

No.	Symbol	I/O	Function	Remark
1	NC	-	This pin should be open.	-
2	NC	-	This pin should be open.	-
3	LED C1	Р	LED cathode 1	-
4	LED A1	Р	LED anode 1	-
5	LED A2	Р	LED anode 2	-
6	LED C2	Р	LED cathode 2	-
7	LED C3	Р	LED cathode 3	-
8	LED A3	Р	LED anode 3	
9	LED A4	Р	LED anode 4	-
10	LED C4	Р	LED cathode 4	-

Note 1: Backlight-side connector: SM10B-SHLS-TF(LF)(SN)(JST) or equivalent.

Note 2: User's Corresponding connector: SHLP-10V-S-B(JST) or equivalent.

3.4 Color Data Input Assignment

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

												C	ata	Signa	al										
	Color				Re	ed							Gre	een							ВІ	ue			
		R7	R6	R5	R4	R3	R2	R1	RO	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	В4	В3	B2	B1	во
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1

												C	ata	Sign	al										
	Color				Re	ed							Gre	een							ВІ	ue			
		R7	R6	R5	R4	R3	R2	R1	RO	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	В4	В3	B2	B1	В0
	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
6	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
of Red	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
oi keu	Red(253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Green(2)	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:
Scale	:			:								:												:	:
of	:			:	:				:															:	
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	0:	1:	0:
Scale		:	:	:		:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
of Blue	:	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(254) Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	_

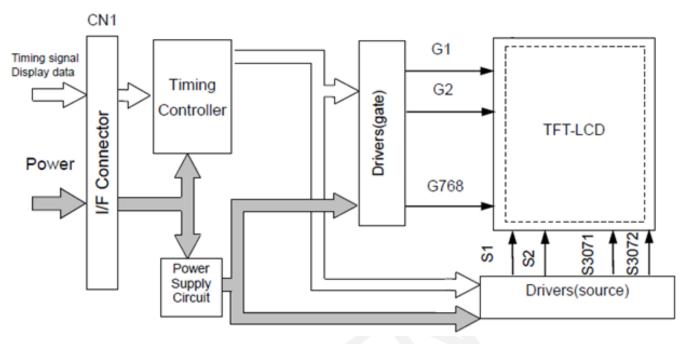
Note 1: 0: Low Level Voltage, 1: High Level Voltage

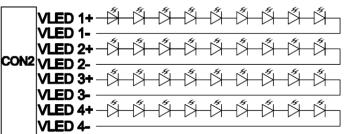
Note 2: Display Position and Scan Direction

Note 3: Scanning Direction

The following figures show the images see from the front view. The arrow indicates the direction of scan.

3.5 Block Diagram





3.6Timing Characteristics

3.6.1 Input Signal Timing Specifications

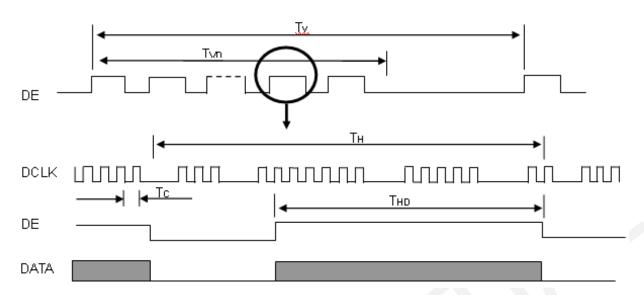
The input signal timing specifications are shown as the following table and timing diagram.

Item	ltem	Symbol	Min	Тур.	Max	Unit	Note
	Frequency	Fc	53.35	65	80	MHz	-
	Period	Тс	12.5	15.38	18.75	ns	-
	Input Cycle to Cycle Jitter	T _{rcl}	-	-	200	ns	1
LVDS Clock	Input Clock to Data Skew	TLVCCS	-0.02*Tc	-	0.02*Tc	Ps	2
	Spread Spectrum Modulation Range	Fclkin_mod	-		1.02*Fc	MHz	
	Spread Spectrum Modulation Frequency	Fssm	-	-	200	KHz	3
	Frame Rate	Fr	55	60	70	Hz	Tv=Tvd+Tvb
Ventical Biomics Terror	Total	Tv	780	806	840	Th	-
Vertical Display Term	Active Display	Tvd	768	768	768	Th	-
	Blank	Tvb	Tv-Tvd	38	Tv-Tvd	Th	-
	Total	Th	1240	1344	1360	Тс	Th=Thd+Thb
Horizontal Display Term	Active Display	Thd	1024	1024	1024	Тс	-
	Blank	Thb	Th-Thd	320	Th-Thd	Тс	-

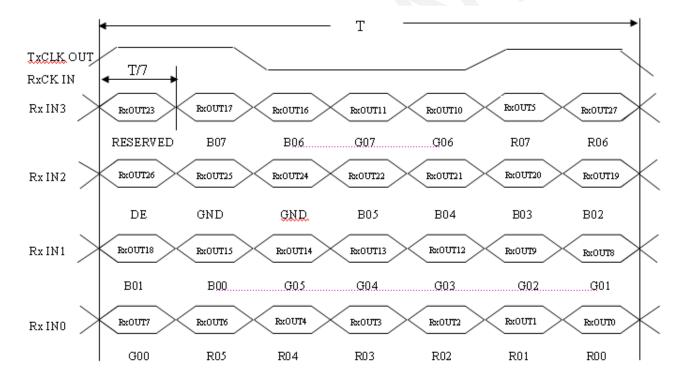
Note 1: Because this module is operated by DE only mode, Hsync and Vsync input signals should be set to low logic level or ground. Otherwise, this module would operate abnormally.

Note 2: The Tv(Tvd+Tvb) must be integer, otherwise, the module would operate abnormally.

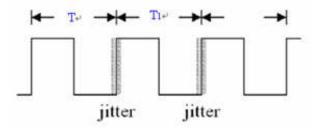
Input Signal Timing Diagram



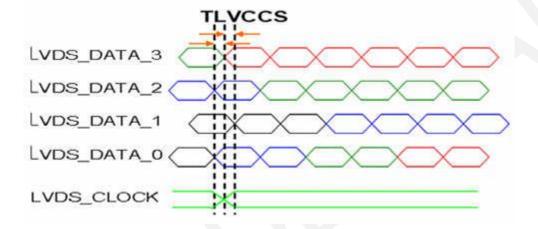
Timing Diagram of LVDS



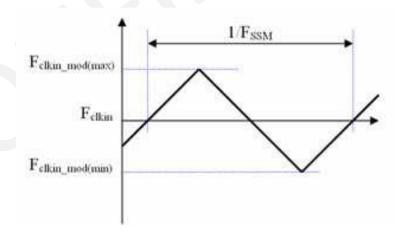
Note 1: The input clock cycle-to-cycle jitter is defined as below figures. Trcl = IT1 - TI



Note 2: Input Clock to data skew is defined as below figures.

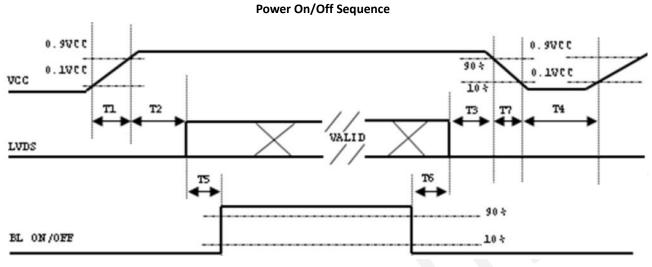


Note 3: The SSCG (Spread spectrum clock generator) is defined as below figures.



3.6.2 Power On/Off Sequence

To prevent a latch-up or DC operation of LCD assembly, the power on/off sequence should be as the diagram below.



Note 1: Please avoid floating state of interface signal at invalid period.

Note 2: When the interface signal is invalid, be sure to pull down the power supply of LCD VCC to 0 V.

Note 3: The Backlight converter power must be turned on after the power supply for the logic and the interface signal is valid.

Item	Min	Тур.	Max	Unit	Note
T1	0.5	-	10	ms	-
T2	0	-	50	ms	-
ТЗ	0	-	50	ms	-
T4	500	-	-	ms	-
T5	450	-	-	ms	-
T6	200	-	-	ms	-
Т7	10	-	100	ms	-

4. Optical Specification

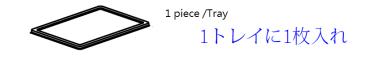
4.1 Optical Characteristics

Charac	cteristics	Symbol	Conditions	Min	Тур.	Max	Unit	Note	
Contra	st Ratio	CR		1800	2500	-	-	2, 5	
D	4:	TR	$\theta = 0^{\circ}$ BM-7 \cdot BM-5	-	16	21		2.5	
Kespo	nse time	TF	DIVI-7 DIVI-3	-	7	14	ms	3,5	
	minance of	Lc	θ = 0° CA-310	640	800	-	cd/m²	4, 5	
	inance ormity	U	θ = 0° BM-7	70	-	-	%	5, 6	
<u> </u>	Left	θх-		80	88	-			
Viewing Angle	Right	θ _x +	CR≧10 BM-7 \ BM-5	80	88	-	Dog	1, 5	
win	Up	θ_{Y} +		80	88	-	Deg.	1, 5	
<u>\$</u>	Down	Өү-		80	88	-			
	Red	Rx			0.64				
	Red	Ry			0.34				
icity	Carre	Gx			0.32				
omat	Green	Gy	θ = 0°	Тур.	0.60	Тур.		4.5.6	
Colour Chromaticity	Divis	Вх	CA-310	-0.05	0.15	+0.05	-	1, 5, 6	
Color	Blue	Ву			0.05				
	\\/\bita	Wx			0.31				
	White				0.34				

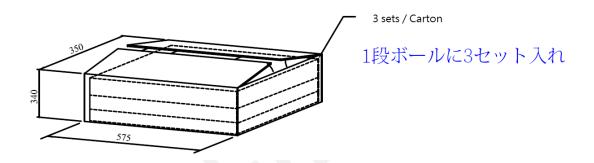
Note	ltem	Test method
1	Definition of Viewing Angle (θx, θy)	Normal $\theta x = \theta y = 0^{\circ}$ $\theta y = \theta y = 0^{\circ}$ $\theta x = \theta y = 0^{\circ}$ $\theta y = \theta y = 0^{\circ}$
2	Definition of Contrast Ratio (CR)	The contrast ratio can be calculated by the following expression. Contrast Ratio (CR) = L255 / L0 L255: Luminance of gray level 255 L 0: Luminance of gray level 0 CR = CR (5) CR (X) is corresponding to the Contrast Ratio of the point X at the figure in Note (6). Contrast ratio (CR) = Luminance measured when LCD is at "white state" Luminance measured when LCD is at "black state"
3	Definition of Response Time (T _R , T _F)	Gray Level 255 Optical Response 10% 0% Gray Level 0 Tr Tr Tr Tr Tr Tr Tr Tr Tr T
4	Definition of Luminance of White (LC)	Measure the luminance of gray level 255 at center point LC = L (5) L (x) is corresponding to the luminance of the point X at Figure in Note (6). Measuring equipment: Konica Minolta CA-310

Note	ltem	Test method
5	Measurement Setup	The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room. LCD Module CA-310 probe BM-7, BM-5A Center of the Screen Light Shield Room (Ambient Luminance < 2 lux)
6	Definition of Luminance Uniformity (U)	Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area. Luminance Uniformity (U) = Lmin/Lmax x100% L = Active area length W = Active area width
7	Definition of color chromaticity	CIE 1931 color spaces. Color coordinates measured at the center point of LCD.

5. Packaging







6. Quality Assurance Specification

6.1 Conformity

The performance, function and reliability of the shipped products conform to the Product Specification.

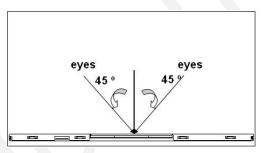
6.2 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

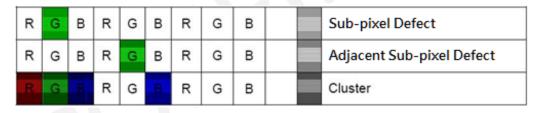
Temperature: 15° C ~ 25° C Humidity: $55 \pm 15\%$

Visual inspection: Illumination More than 500 Lux; Inspection Distance: 20cm~30cm Electrical inspection: Illumination 100Lux~300Lux; Inspection Distance: 20cm~30cm

Visual angle: The test direction is base on about around 45° of Vertical line

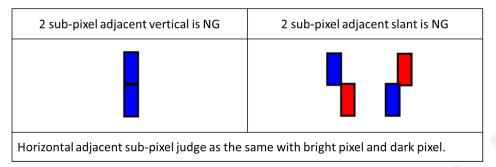


Sub-pixel Definition:



- Note 1. If pixel or partial sub-pixel defects exceed 50% of the affected pixel or sub-pixel area, it shall be considered as 1 defect.
- Note 2. There should be no distinct non-uniformity visible through 5% ND Filter within 2 seconds inspection times.
- Note 3. Mura and bright sub-pixel inspected through 5% transmission ND Filter as following.

Note 4. The judging criteria for the arrangement of 2 adjacent bright sub-pixels are as follows, please refer to the item Bright sub-pixel . Dark sub-pixel On-display Pixel on Inspection Criteria for the allowable quantity and bright sub-pixel size judgment standards.

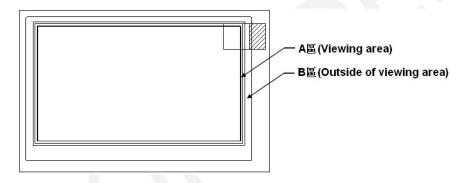


6.3 Delivery Assurance

6.3.1 **Delivery Inspection Standards**

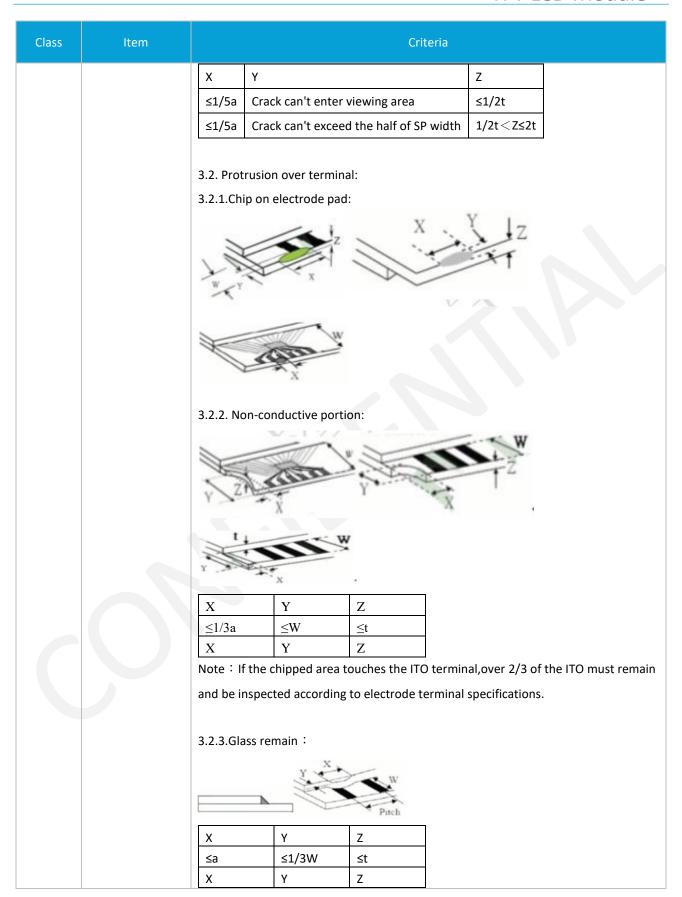
Class II, Normal Inspection, MIL-STD-105E

6.3.2 **Zone Definition**



6.3.3 Inspection Criteria

Class	Item	Criteria
Maj	Packing & Indicate	1.1. Mixed product types.1.2. The part number is inconsistent with work order of production.1.3. Assembled in inverse direction.1.4. The quantity is inconsistent with work order of production.
Maj	Size	Product size and structure must meet the structure diagram
Min	The crack of glass	Symbols: X: The length of crack. Y: The width of crack. Z: The thickness of crack. W: Terminal length. T: The thickness of glass. a:LCD side length. 3.1. General glass chip: 3.1.1. Chip on panel surface and crack between panels; Seal width X Y Seal Crack can't enter viewing area S1/2t Crack can't exceed the half of SP width 1/2t < Z > 2



Class	Item		Criteria					
		Round type: as per following drawing, $\emptyset = (X+Y)/2$						
Min	Spot Defect	4.1 Round type (Non-display	or display):					
		Judging standard	ceptable Quantity					
		Ø≤0.3 mm		Ignore				
		0.3<∅≤0.5mm		5				
		0.5 mm<∅		0				
N dia	Line Defect (LCD/ Polarizer	5.1 Line type: as per followin	g drawing L					
Min	backlight	5.1 Line type(Non-display or	display):					
	black/white line,	Judging s	tandard	Acceptable Quantity				
	scratch, stain)	W≤0.07 mm	-	Ignore				
		0.07 mm <w≤0.1 mm<="" td=""><td>L≤5 mm</td><td>5</td></w≤0.1>	L≤5 mm	5				
		0.1 mm <w< td=""><td>L > 5 mm</td><td>0</td></w<>	L > 5 mm	0				
		Area	Judging standard	Acceptable Quantity				
			Ø < 0.2 mm	Ignore				
		A area (Viewing area)	0.2mm $<$ \varnothing \leq 0.3mm	3				
Min	Polarizer Bubble	A area (Viewing area)	0.3 mm $<$ \varnothing \leq 0.5 mm	1				
			0.5mm<∅	0				
		B area (Outside of viewing	-	Ignore				
		area)						
Min	The folding and peeled off in polarizer	The folding and peeled off in (Degumming)polarizer are not acceptable.						
Maj	Brightness and uniformity \ Chroma							

Class	ltem		Criteria	
Maj	MURA	5% ND Filter		
Maj	Electrical Testing	 Missing line chara No function or no Display malfuncti LCD viewing angle Current consump 	o display. on.	
	Bright pixel、			
Min	Dark pixel On- display	Item	Judging standard	Acceptable Quantity
141111	Pixel : 3 sub-	Dright Dival	D≦1/2 Pixel	Ignore
	pixel in 1 pixel	Bright Pixel	1/2 Pixel < D≦1 Pixel	3
		David Birral	D≦1/2 Pixel	Ignore
		Dark Pixel	1/2 Pixel < D≦1 Pixel	4
			Total	6

6.3.4 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

6.3.5 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

7. Reliability Specification

7.1 Reliability Tests

Test Item	Content of Test	Test Condition	Note
High Temperature	Endurance test applying the high storage	80 ℃	2
storage	temperature for a long time.	240hrs	
Low Temperature	Endurance test applying the low storage	-20 °℃	1,2
storage	temperature for a long time.	240hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 ℃ 240 hrs	-
Low Temperature	Endurance test applying the electric stress under	-20 ℃	1
Operation	low temperature for a long time.	240hrs	1
High Temperature/	The module should be allowed to stand at 60	40°C,90%RH	1.2
Humidity Operation	°C,90%RH max	240hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/80°C 100 cycles	-
Vibration test	Endurance test applying the vibration during transportation and using.	[9.8 m/s2] (≒1.0G)(Sine wave) Vibration Frequency: 5~500Hz(0.5 8⁰/ 1 minutes) One cycle 60 minutes to 3 directions of X,Y,Z for Each ,total 180 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= $\pm 8kV$ (contact), RS= 330Ω ,CS= $150pF$ 10 times/s VS= $\pm 200v$ (air), RS= 0Ω ,CS= $200pF$ 10 times/s	-

Test Item	Content of Test	Test Condition	Note
Impact Testing	Determine the strength and impact value of the material, and judge the toughness and brittleness of the material according to the measured experimental value	[980 m/s2] (≒100G) (1/2Sine wave) 2ms (±X, ±Y, ±Z) One cycle each, 6 times in total	-

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

7.1.1 Inspection Check Standard

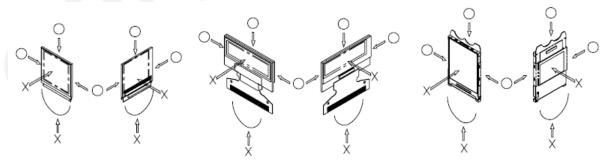
After the completion of the described reliability test, the samples are to be left at room temperature for 4 hrs prior to conducting the inspection check at 25 ± 2 °C, $50\pm10\%$ RH.

^{*}Even there's minor defects on the exterior, as long as the electrical characteristics are within the standard, we'll accept it. For the points that are not listed on the spec. sheet, please confirm with us.

8. Handling Precautions

8.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water
- 4) If pressure is applied to the display surface or its neighborhood of the display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 5) The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) When the surface of the polarizer of the display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - a. Scotch Mending Tape No. 810 or an equivalent
 - b. Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - c. Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - Water
 - Ketone
 - Aromatic Solvents
- 7) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not over bend the film with electrode pattern layouts. These stresses will



influence the display performance. Also, secure sufficient rigidity for the outer cases.

- 8) Do not apply stress to the LSI chips and the surrounding molded sections.
- 9) Do not disassemble nor modify the display module.
- 10) Do not apply input signals while the logic power is off.
- 11) Pay sufficient attention to the working environments when handing display modules to prevent occurrence of element breakage accidents by static electricity.

- a. Be sure to make human body grounding when handling display modules.
- b. Be sure to ground tools to use or assembly such as soldering irons.
- c. To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- d. Protective film is being applied to the surface of the display panel of the display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 12) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 13) If electric current is applied when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

8.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

8.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.

8.4 Operation Precautions

- 1) It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
 - a. Pins and electrodes
 - b. Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
 - a. Design the product and installation method so that the driver may be shielded from light in actual usage.
 - b. Design the product and installation method so that the driver may be shielded from light during the inspection processes.
- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

8.5 Other Precautions

1) Request the qualified companies to handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.